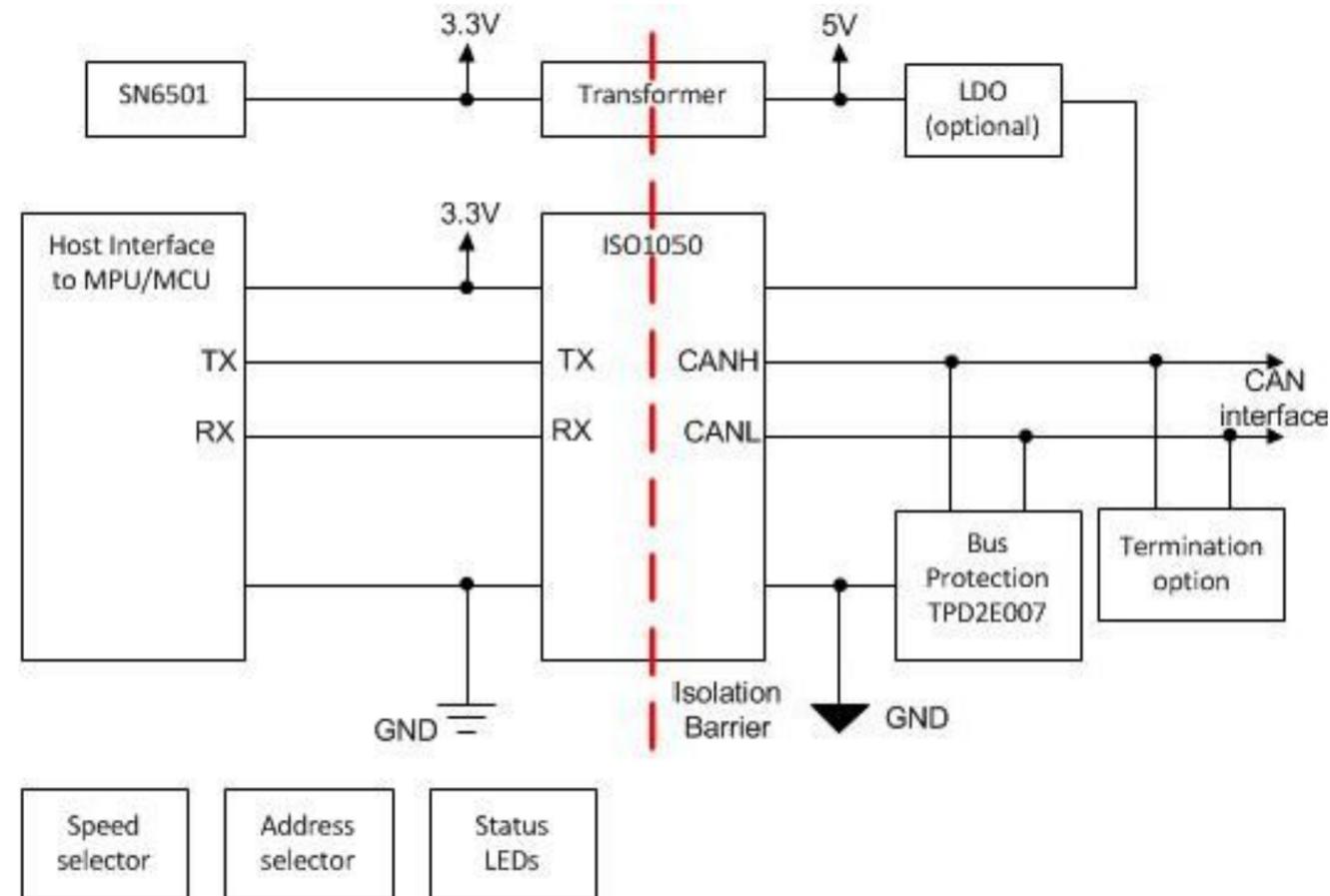


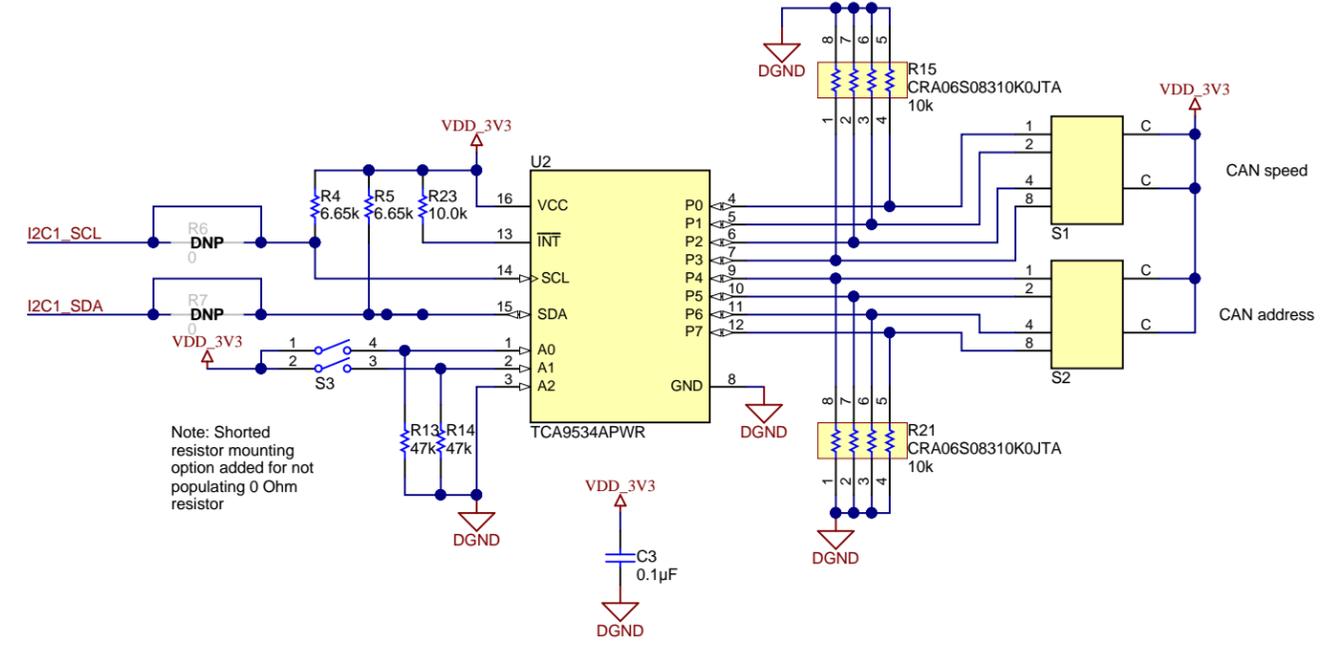
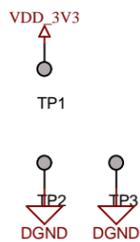
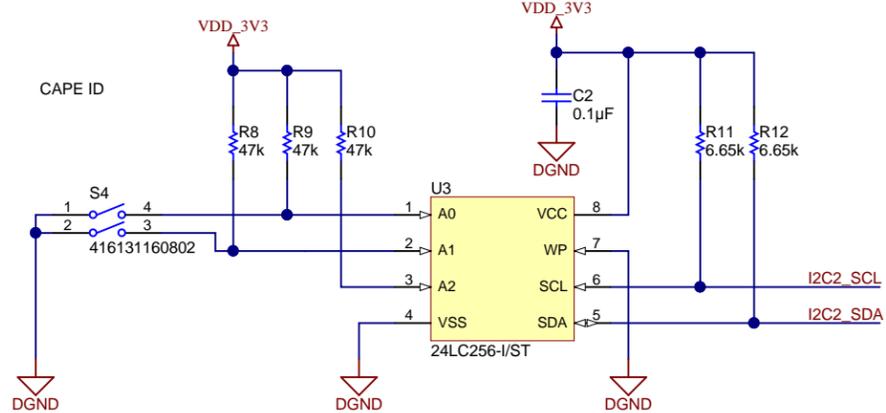
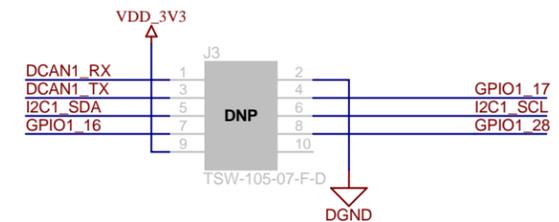
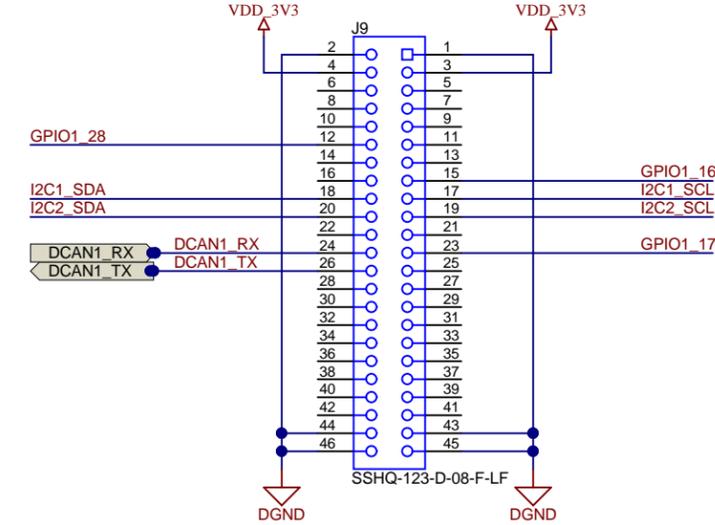
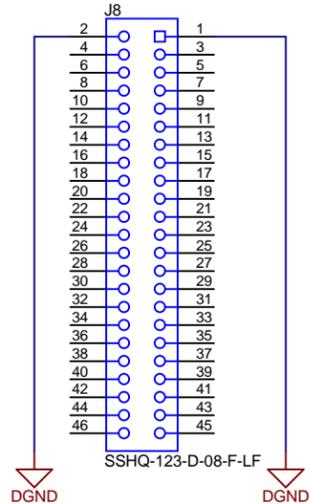
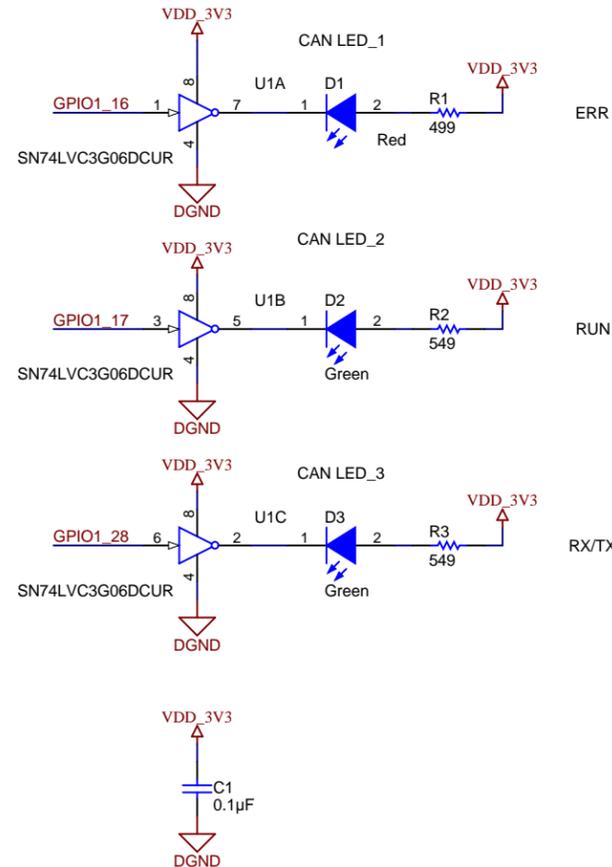
Revision History

Rev	ECN #	Approved Date	Approved by	Notes
N/A	N/A	N/A	N/A	N/A



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TID #: <a href="#">TIDA-01406</a>	Project Title: <a href="#">Energy efficient and isolated CANopen interface</a>		
Number: <a href="#">TIDA-01406</a>	Rev: <a href="#">E1</a>	Sheet Title:	
SVN Rev: <a href="#">Version control disabled</a>	Assembly Variant: <a href="#">001</a>	Sheet: <a href="#">1 of 3</a>	
Drawn By:	File: <a href="#">TIDA-01406A_CoverSheet.SchDoc</a>	Size: <a href="#">B</a>	
Engineer: <a href="#">Thomas Mauer</a>	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>		

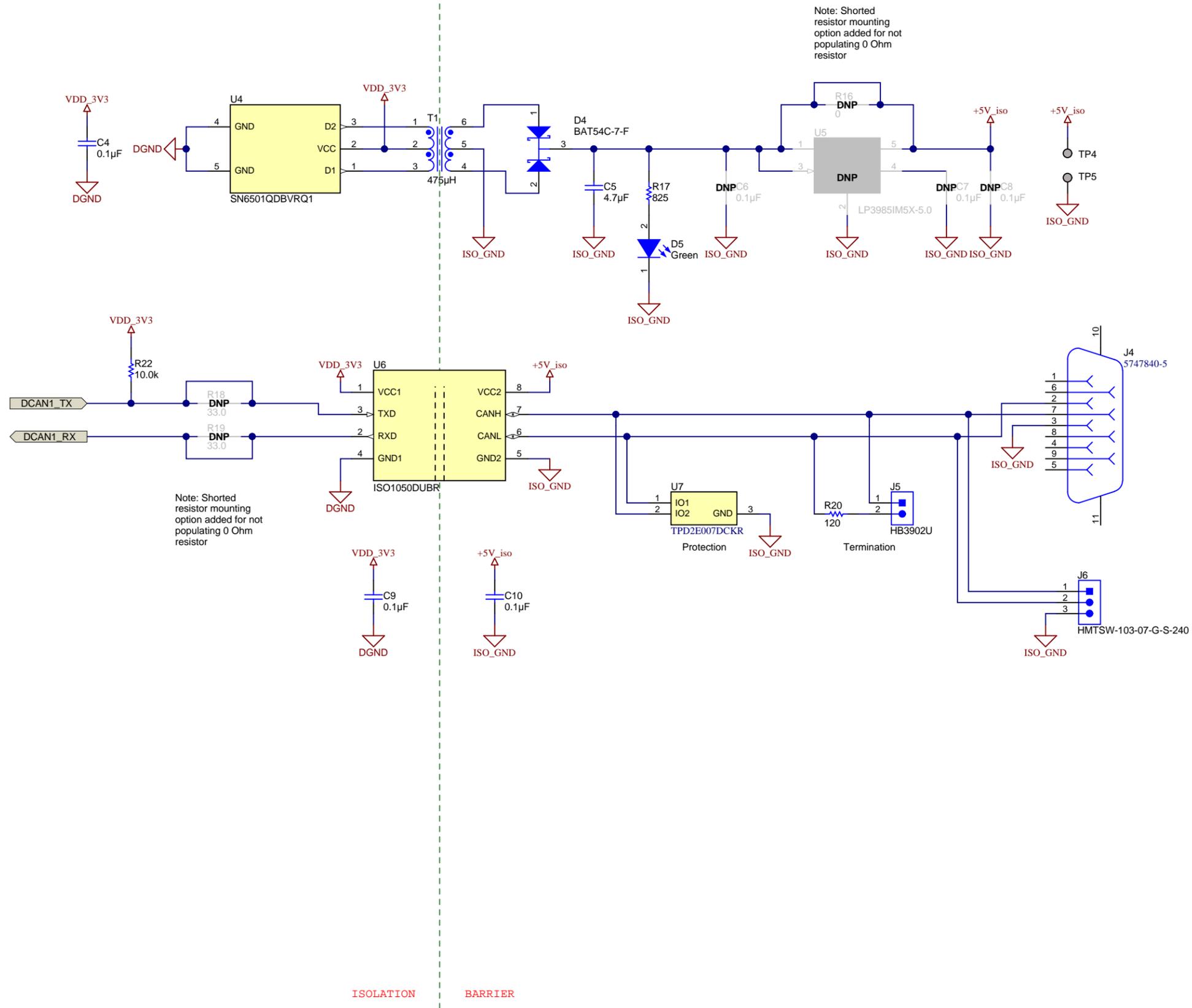


Note: Shorted resistor mounting option added for not populating 0 Ohm resistor

Orderable: ChangeMe!	Designed for: Public Release	Mod. Date: 3/9/2017
TID #: TIDA-01406	Project Title: Energy efficient and isolated CANopen interface	
Number: TIDA-01406	Rev: E1	Sheet Title: PLC LED Driver
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 3
Drawn By: Thomas Mauer	File: TIDA_01406A_Cape.SchDoc	Size: B
Engineer: Thomas Mauer	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	

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Note: Shorted resistor mounting option added for not populating 0 Ohm resistor

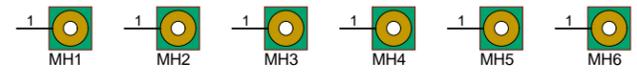
Note: Shorted resistor mounting option added for not populating 0 Ohm resistor

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TID #: TIDA-01406	Project Title: Energy efficient and isolated CANopen interface	
Number: TIDA-01406	Rev: E1	Sheet: 2 of 3
SVN Rev: Version control disabled	Assembly Variant: 001	Size: B
Drawn By: Thomas Mauer	File: TIDA-01406A_ISO_Interface.SchDoc	http://www.ti.com
Engineer: Thomas Mauer	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	© Texas Instruments 2017





PCB Number: TIDA-01406  
PCB Rev: E1

PCB LOGO  
Texas Instruments

PCB LOGO  
Pb-Free Symbol

PCB LOGO  
FCC disclaimer

Variant/Label Table	
Variant	Label Text
001	ChangeMe!
002	ChangeMe!

LBL1  
PCB Label  
Size: 0.65" x 0.20"

ZZ1  
Label Assembly Note  
This Assembly Note is for PCB labels only

ZZ2  
Assembly Note  
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3  
Assembly Note  
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4  
Assembly Note  
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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